## JJMICROELECTRONICS

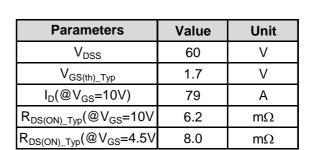
# 60V, 79A, 8mΩ N-channel Power SGT MOSFET JMSL0608PG

#### Features

- Excellent  $\mathsf{R}_{\mathsf{DS}(\mathsf{ON})}$  and Low Gate Charge
- 100% UIS Tested
- 100% ΔVds Tested
- Halogen-free; RoHS-compliant

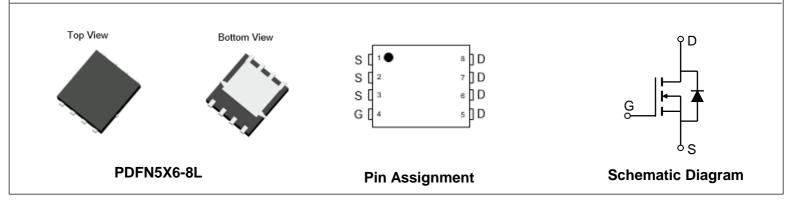
#### Applications

- Load Switch
- PWM Application
- Power Management





**Product Summary** 



#### **Ordering Information**

Device	Marking	MSL	Form	Package	Reel(pcs)	Per Carton (pcs)
JMSL0608PG	SL0608P	1	Tape&Reel	PDFN5x6-8L	5000	50000

#### Absolute Maximum Ratings (@ T<sub>c</sub> = 25°C unless otherwise specified)

Symbol	Parameter		Value	Unit	
V <sub>DS</sub>	Drain-to-Source Voltage		60	V	
V <sub>GS</sub>	Gate-to-Source Voltage		±20	V	
ID	Continuous Drain Current	$T_C = 25^{\circ}C$	79	А	
	Continuous Drain Current	T <sub>C</sub> = 100°C	50	A	
I <sub>DM</sub>	Pulsed Drain Current <sup>(1)</sup>		Refer to Fig.4	A	
E <sub>AS</sub>	Single Pulsed Avalanche Energy <sup>(2)</sup>		89	mJ	
P <sub>D</sub>	Power Dissipation	$T_C = 25^{\circ}C$	89	w	
		$T_{\rm C} = 100^{\circ}{\rm C}$	36	٧V	
T <sub>J</sub> , T <sub>STG</sub>	Junction & Storage Temperature Range		-55 to 150	°C	

#### **Thermal Characteristics**

Symbol	Parameter	Мах	Unit	
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient <sup>(3)</sup>	44	°C/M	
$R_{\theta JC}$	Thermal Resistance, Junction to Case	1.4	°C/W	

	_				
Parameter	Conditions	Min.	Тур.	Max.	Unit
racteristics					
Drain-Source Breakdown Voltage	$I_{D} = 250 \mu A, V_{GS} = 0V$	60	-	-	V
Zero Gate Voltage Drain Current	$V_{DS} = 48V, V_{GS} = 0V$	-	-	1.0	μA
Gate-Body Leakage Current	$V_{DS} = 0V, V_{GS} = \pm 20V$	-	-	±100	nA
racteristics				•	
Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250 \mu A$	1.2	1.7	2.2	V
	$V_{GS} = 10V, I_D = 20A$	-	6.2	8.0	mΩ
Static Drain-Source ON-Resistance	$V_{GS} = 4.5V, I_{D} = 15A$	-	8.0	10.4	mΩ
c Characteristics			-		
Gate Resistance	f = 1MHz	-	1.6	-	Ω
Input Capacitance		852	1193	1610	pF
Output Capacitance		375	525	709	pF
Reverse Transfer Capacitance		26	36	49	pF
Total Gate Charge		16	22	30	nC
Gate Source Charge		-	3.9	-	nC
Gate Drain("Miller") Charge	$V_{\rm DS} = 500$ , $I_{\rm D} = 20$ A	-	5.1	-	nC
	Т — Т		-	1	
· · ·	4	-	7.6	-	ns
Turn-On Rise Time	$V_{GS} = 10V, V_{DD} = 30V$	-	20	-	ns
Turn-Off DelayTime	$I_D = 20A, R_{GEN} = 3\Omega$	-	22	-	ns
Turn-Off Fall Time		-	6.6	-	ns
iode Characteristics			I	-	
Maximum Continuous Body Diode Forward Current		-	-	79	A
Maximum Pulsed Body Diode Forward Current		-	-	315	А
Body Diode Forward Voltage	$V_{GS} = 0V, I_{S} = 20A$	-		1.2	V
Body Diode Reverse Recovery Time	L = 200 di/dt = 1000/wa	22	31	41	ns
Body Diode Reverse Recovery Charge	$_{\rm F} = 20$ A, ui/ut = 100 A/US	-	23	-	nC
	racteristics Drain-Source Breakdown Voltage Zero Gate Voltage Drain Current Gate-Body Leakage Current racteristics Gate Threshold Voltage Static Drain-Source ON-Resistance <sup>(4)</sup> c Characteristics Gate Resistance Input Capacitance Output Capacitance Reverse Transfer Capacitance Total Gate Charge Gate Source Charge Gate Drain("Miller") Charge rurn-On DelayTime Turn-On Rise Time Turn-On Rise Time Turn-Off DelayTime Turn-Off Fall Time iode Characteristics Maximum Continuous Body Diode Forward Maximum Pulsed Body Diode Forward Curr Body Diode Forward Voltage Body Diode Reverse Recovery Time	racteristicsDrain-Source Breakdown Voltage $I_D = 250 \mu A, V_{GS} = 0V$ Zero Gate Voltage Drain Current $V_{DS} = 48V, V_{GS} = 0V$ Gate-Body Leakage Current $V_{DS} = 0V, V_{GS} = \pm 20V$ racteristics $V_{DS} = 0V, V_{GS} = \pm 20V$ Gate Threshold Voltage $V_{DS} = V_{GS}, I_D = 250 \mu A$ Static Drain-Source ON-Resistance <sup>(4)</sup> $V_{GS} = 10V, I_D = 20A$ Static Drain-Source ON-Resistance <sup>(4)</sup> $V_{GS} = 10V, I_D = 15A$ c Characteristics $f = 1MHz$ Gate Resistance $f = 1MHz$ Input Capacitance $V_{GS} = 0V, V_{DS} = 30V, f = 1MHz$ Output Capacitance $V_{GS} = 0V, V_{DS} = 30V, f = 1MHz$ Total Gate Charge $V_{GS} = 0 to 10V$ Gate Source Charge $V_{GS} = 0 to 10V$ Gate Drain("Miller") Charge $V_{GS} = 10V, V_{DD} = 30V$ Turn-On DelayTime $V_{GS} = 10V, V_{DD} = 30V$ Turn-Off DelayTime $V_{GS} = 10V, V_{DD} = 30V$ Turn-Off Fall Time $V_{GS} = 0V, I_S = 30Q$ iode CharacteristicsMaximum Continuous Body Diode Forward CurrentMaximum Pulsed Body Diode Forward CurrentBody Diode Forward VoltageV_{GS} = 0V, I_S = 20A, di/dt = 100A/us	racteristicsDrain-Source Breakdown Voltage $I_D = 250 \mu A, V_{GS} = 0V$ 60Zero Gate Voltage Drain Current $V_{DS} = 48V, V_{GS} = 0V$ -Gate-Body Leakage Current $V_{DS} = 0V, V_{GS} = \pm 20V$ -racteristicsGate Threshold Voltage $V_{DS} = V_{GS}, I_D = 250 \mu A$ 1.2Static Drain-Source ON-Resistance <sup>(4)</sup> $V_{GS} = 10V, I_D = 20A$ -Static Drain-Source ON-Resistance <sup>(4)</sup> $V_{GS} = 0V, V_{DS} = 30V, I_D = 15A$ -CharacteristicsGate Resistance $f = 1MHz$ -Input Capacitance $V_{GS} = 0V, V_{DS} = 30V, I_D = 10V, V_{DS} = 30V, I_D = 10Hz$ Output Capacitance $V_{GS} = 0V, V_{DS} = 30V, I_D = 20A, I_D $	racteristicsDrain-Source Breakdown Voltage $I_D = 250 \mu A, V_{GS} = 0V$ 60Zero Gate Voltage Drain Current $V_{DS} = 48V, V_{GS} = 0V$ -Gate-Body Leakage Current $V_{DS} = 0V, V_{GS} = 20V$ -racteristicsGate Threshold Voltage $V_{DS} = 0V, V_{GS} = 250 \mu A$ 1.21.7Static Drain-Source ON-Resistance <sup>(4)</sup> $V_{GS} = 10V, I_D = 20A$ -6.2V_{GS} = 4.5V, I_D = 15A-8.0-c Characteristics-1.6-Gate Resistancef = 1MHz-1.6Input Capacitancef = 1MHz-1.6Input CapacitanceV_{GS} = 0V, V_{DS} = 30V, f = 1MHz375525Reverse Transfer CapacitanceV_{GS} = 0 to 10V-3.9Gate Source ChargeV_{GS} = 0 to 10V-5.1Itam-On DelayTime-7.6-20Turn-On DelayTime6.622Turn-Off DelayTime6.622Itam-Off Fall Time6.6Ode CharacteristicsMaximum Continuous Body Diode Forward CurrentBody Diode Forward Voltage $V_{GS} = 0V, I_S = 20A$ Body Diode Reverse Recovery Time $I_F = 20A, di/dt = 100A/us$ 2231	racteristics         Image: source Breakdown Voltage         Ib = 250 \muA, V_{GS} = 0V         60         -         -           Zero Gate Voltage Drain Current $V_{DS} = 48V, V_{GS} = 0V$ -         -         1.0           Gate-Body Leakage Current $V_{DS} = 0V, V_{GS} = \pm 20V$ -         - $\pm 100$ racteristics           Gate Threshold Voltage $V_{DS} = V_{GS}, I_D = 250\mu$ A         1.2         1.7         2.2           Static Drain-Source ON-Resistance <sup>(4)</sup> $V_{GS} = 10V, I_D = 20A$ -         6.2         8.0           Static Drain-Source ON-Resistance <sup>(4)</sup> $V_{GS} = 10V, I_D = 20A$ -         6.2         8.0           Static Drain-Source ON-Resistance         f = 1MHz         -         8.0         10.4           Characteristics           Gate Resistance         f = 1MHz         -         8.0         10.4           Output Capacitance         f = 1MHz         -         1.6         -           Input Capacitance         f = 1MHz         -         1.6         -           Total Gate Charge         V_{GS} = 0V, V_{DS} = 30V, I_D = 20A         -         5.1         -           Gate Source Charge         V_{GS} = 10V, V_{DD} = 30V, I_D = 20A

#### **Electrical Characteristics** ( $T_J = 25^{\circ}C$ unless otherwise specified)

Notes: 1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.

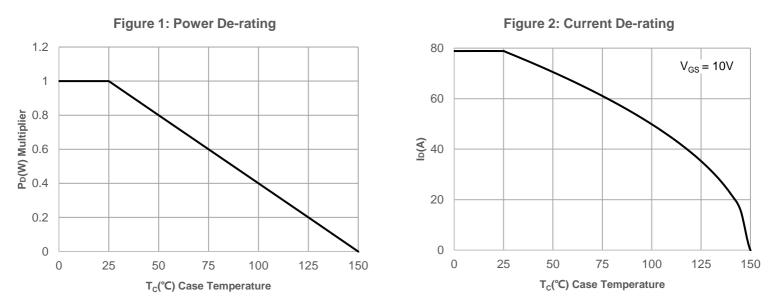
2.  $E_{AS}$  condition: Starting  $T_J$ =25C,  $V_{DD}$ =30V,  $V_G$ =10V,  $R_G$ =25ohm, L=3mH,  $I_{AS}$ =7.7A,  $V_{DD}$ =0V during time in avalanche.

3.  $R_{\theta JA}$  is measured with the device mounted on a 1inch  $^2$  pad of 2oz copper FR4 PCB.

4. Pulse Test: Pulse Width  ${\leqslant}300\mu s,$  Duty Cycle  ${\leqslant}0.5\%.$ 

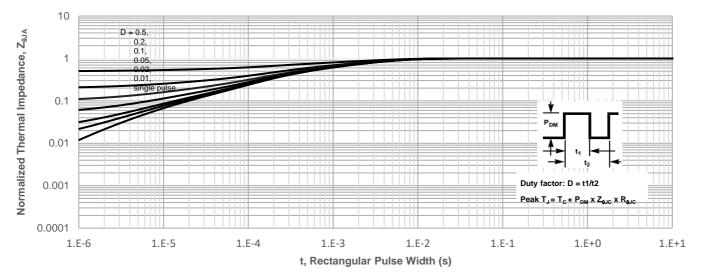




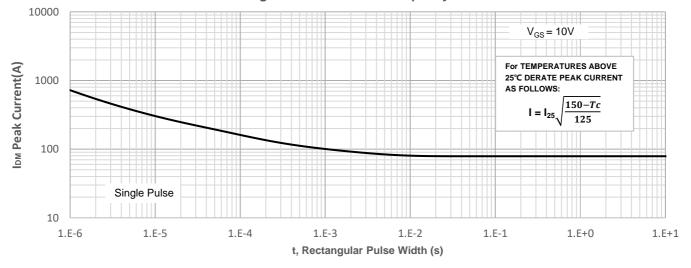


## **Typical Performance Characteristics**

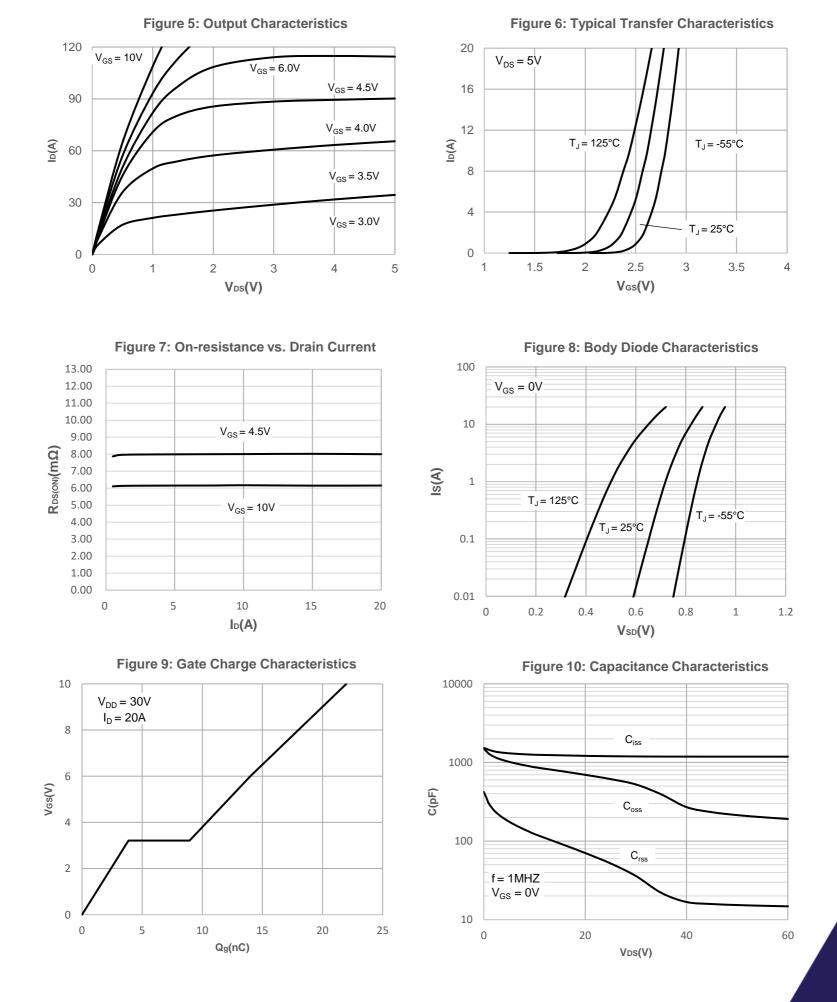




#### Figure 4: Peak Current Capacity





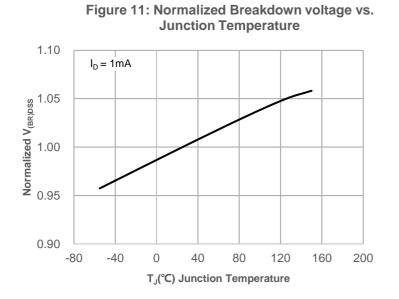


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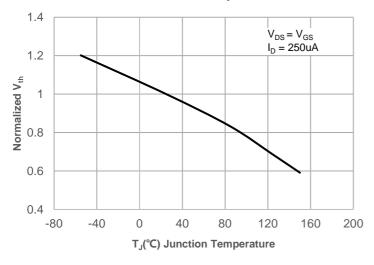
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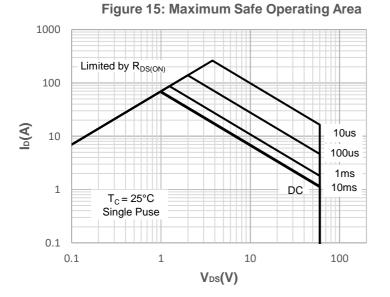


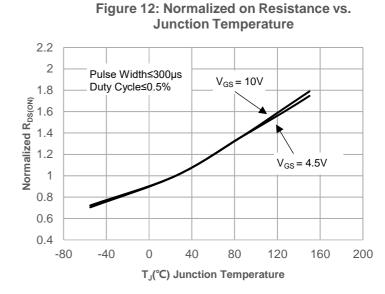
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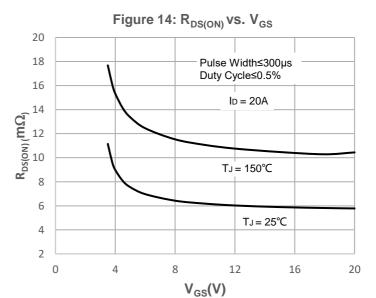












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## **Test Circuit**

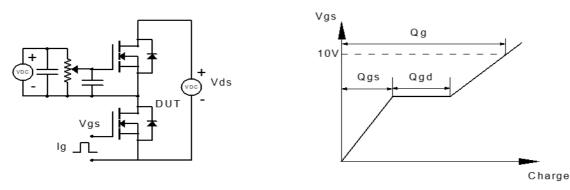


Figure 1: Gate Charge Test Circuit & Waveform

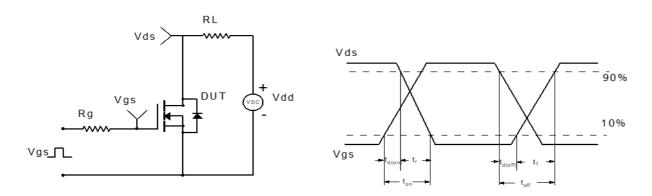


Figure 2: Resistive Switching Test Circuit & Waveform

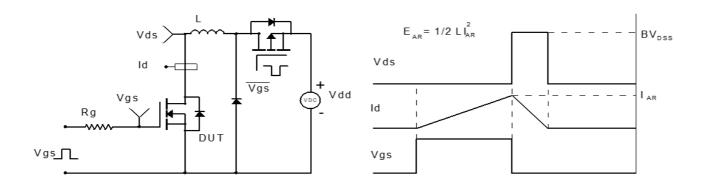


Figure 3: Unclamped Inductive Switching Test Circuit& Waveform

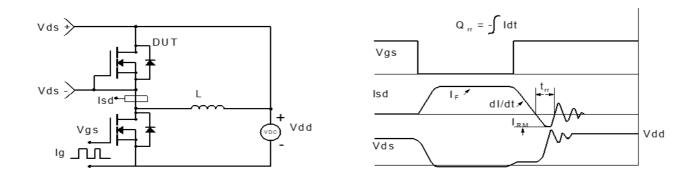
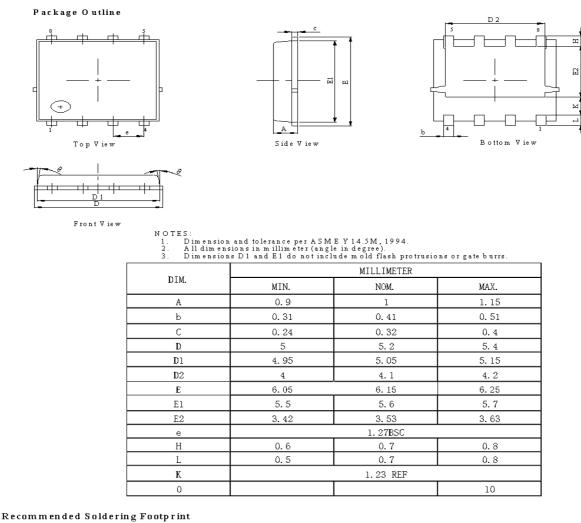
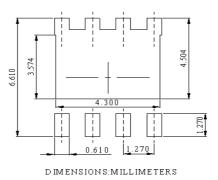


Figure 4: Diode Recovery Test Circuit & Waveform



## Package Mechanical Data(PDFN5X6-8L)





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